

May 2001

QFET[™]

FQD20N06L / FQU20N06L

60V LOGIC N-Channel MOSFET

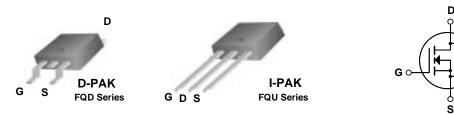
General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as automotive, DC/DC converters, and high efficiency switching for power management in portable and battery operated products.

Features

- 17.2A, 60V, $R_{DS(on)} = 0.06\Omega$ @ $V_{GS} = 10V$
- Low gate charge (typical 9.5 nC)
- Low Crss (typical 35 pF)
- Fast switching
- 100% avalanche tested
- · Improved dv/dt capability
- 150°C maximum junction temperature rating
- Low level gate drive requirements allowing direct operation form logic drivers



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQD20N06L / FQU20N06L	Units
V _{DSS}	Drain-Source Voltage		60	V
I _D	Drain Current - Continuous (T _C = 25°C)		17.2	Α
	- Continuous (T _C = 100°C)		10.9	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	68.8	Α
V _{GSS}	Gate-Source Voltage		± 20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	170	mJ
I _{AR}	Avalanche Current	(Note 1)	17.2	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	3.8	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns
P _D	Power Dissipation (T _A = 25°C) *		2.5	W
	Power Dissipation (T _C = 25°C)		38	W
	- Derate above 25°C		0.30	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		3.28	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		110	°C/W

* When mounted on the minimum pad size recommended (PCB Mount)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, Referenced to 25°C		0.06		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 48 V, T _C = 125°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -20 V, V _{DS} = 0 V			-100	nA
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1.0		2.5	V
R _{DS(on)}	Static Drain-Source	V _{GS} = 10 V, I _D = 8.6 A		0.046	0.06	0
(,	On-Resistance	$V_{GS} = 5 V, I_D = 8.6 A$		0.057	0.075	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 25 \text{ V}, I_D = 8.6 \text{ A}$ (Note 4)		11		S
C _{oss}	Output Capacitance Reverse Transfer Capacitance	f = 1.0 MHz		175 35	230 45	pF pF
C _{rss}	Reverse Transfer Capacitance	1 – 1.0 WH12		35	45	pF
Switch	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, I_{D} = 10.5 \text{ A},$		10	30	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$		165	340	ns
t _{d(off)}	Turn-Off Delay Time			35	80	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		70	150	ns
٣				9.5	13	nC
Q _g	Total Gate Charge	$V_{DS} = 48 \text{ V}, I_{D} = 21 \text{ A},$				
Q _g	Total Gate Charge Gate-Source Charge	$V_{DS} = 48 \text{ V}, I_{D} = 21 \text{ A},$ $V_{GS} = 5 \text{ V}$		2.5		nC
Q _g	9			2.5 5.5		nC nC
Q _g Q _{gs} Q _{gd}	Gate-Source Charge	V _{GS} = 5 V (Note 4, 5)				
Q_g Q_{gs} Q_{gd} Drain-S	Gate-Source Charge Gate-Drain Charge	V _{GS} = 5 V (Note 4, 5)				
Q_g Q_{gs} Q_{gd} Drain-S Q_{gd}	Gate-Source Charge Gate-Drain Charge Source Diode Characteristics and	V _{GS} = 5 V (Note 4, 5) nd Maximum Ratings ode Forward Current Forward Current		5.5		nC
Q _g Q _{gs} Q _{gd}	Gate-Source Charge Gate-Drain Charge Source Diode Characteristics and Maximum Continuous Drain-Source Diode	V _{GS} = 5 V (Note 4, 5) nd Maximum Ratings ode Forward Current		5.5	17.2	nC A
Q _g Q _{gs} Q _{gd} Drain-S	Gate-Source Charge Gate-Drain Charge Source Diode Characteristics at Maximum Continuous Drain-Source Diode Maximum Pulsed Drain-Source Diode F	V _{GS} = 5 V (Note 4, 5) nd Maximum Ratings ode Forward Current Forward Current		5.5 	17.2 68.8	nC A A

Typical Characteristics

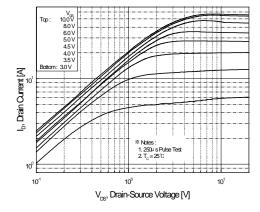


Figure 1. On-Region Characteristics

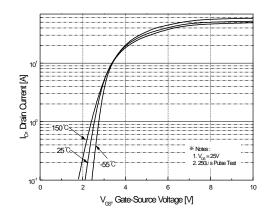


Figure 2. Transfer Characteristics

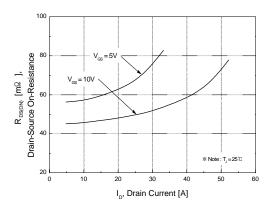


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

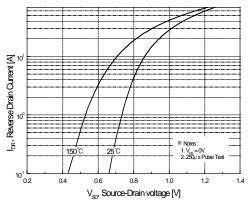


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

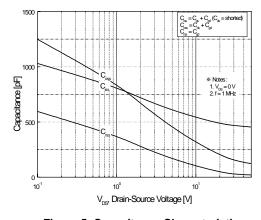


Figure 5. Capacitance Characteristics

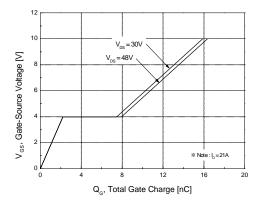
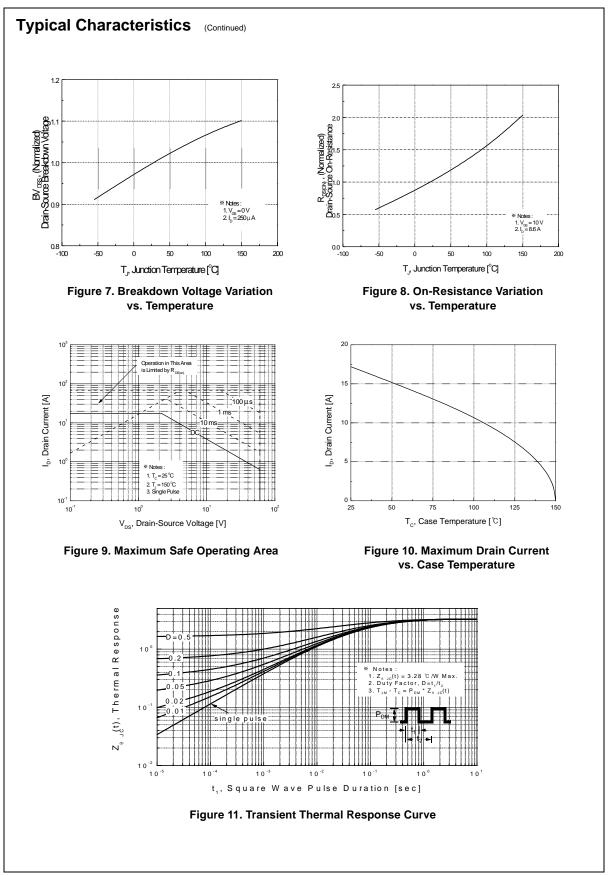
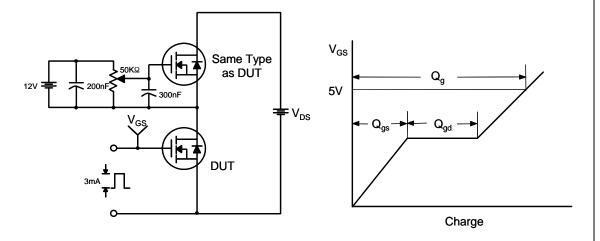


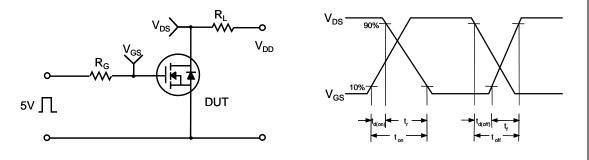
Figure 6. Gate Charge Characteristics



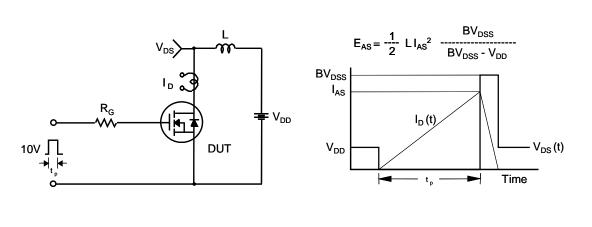
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

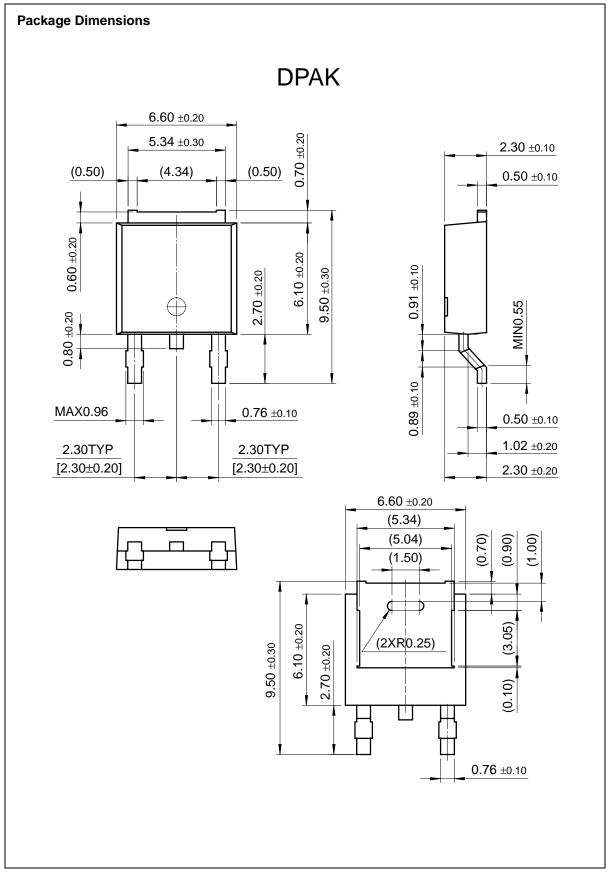


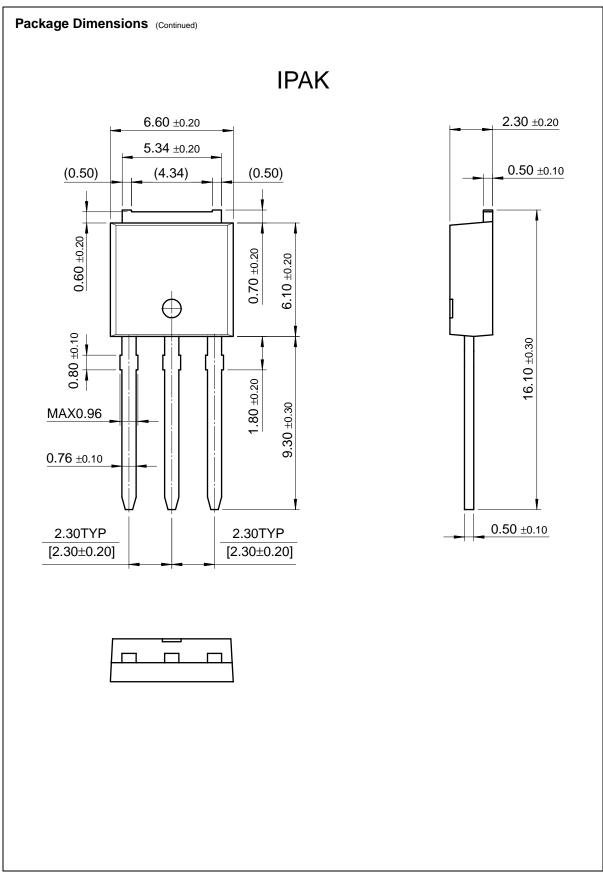
Unclamped Inductive Switching Test Circuit & Waveforms



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Peak Diode Recovery dv/dt Test Circuit & Waveforms DUT I_{SD o} Driver Same Type as DUT V_{DD} • dv/dt controlled by R_G • I_{SD} controlled by pulse period Gate Pulse Width V_{GS} Gate Pulse Period 10V (Driver) I_{FM} , Body Diode Forward Current \mathbf{I}_{SD} di/dt (DUT) I_{RM} **Body Diode Reverse Current** V_{DS} (DUT) Body Diode Recovery dv/dt **Body Diode** Forward Voltage Drop





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